



BUK9M8R5-40H

N-channel 40 V, 8.5 mΩ logic level MOSFET in LPAK33

5 June 2024

Product data sheet

1. General description

Automotive qualified logic level N-channel MOSFET in an LPAK33 package using Trench 9 TrenchMOS technology. This product has been designed and qualified to AEC-Q101 for use in high performance automotive applications.

2. Features and benefits

- Fully automotive qualified to AEC-Q101 at 175 °C
- Trench 9 superjunction technology:
 - Low power losses, high power density
- LPAK copper clip package technology:
 - High robustness and reliability
 - Gull wing leads for high manufacturability and AOI
- Repetitive avalanche rated

3. Applications

- 12 V automotive systems
- Powertrain, chassis, body and infotainment applications
- Medium/Low power motor drive
- DC-DC systems
- LED lighting

4. Quick reference data

Table 1. Quick reference data

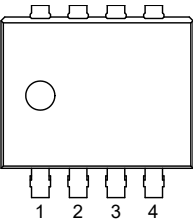
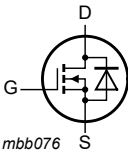
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{DS}	drain-source voltage	$25\text{ °C} \leq T_j \leq 175\text{ °C}$		-	-	40	V
I_D	drain current	$V_{GS} = 10\text{ V}$; $T_{mb} = 25\text{ °C}$; Fig. 2	[1]	-	-	40	A
P_{tot}	total power dissipation	$T_{mb} = 25\text{ °C}$; Fig. 1		-	-	59	W
Static characteristics							
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = 10\text{ V}$; $I_D = 15\text{ A}$; $T_j = 25\text{ °C}$; Fig. 11		5	7.2	8.5	mΩ
Dynamic characteristics							
Q_{GD}	gate-drain charge	$I_D = 15\text{ A}$; $V_{DS} = 20\text{ V}$; $V_{GS} = 4.5\text{ V}$; Fig. 13 ; Fig. 14		-	2.1	4.2	nC
Source-drain diode							
Q_r	recovered charge	$I_S = 15\text{ A}$; $dI_S/dt = -100\text{ A/}\mu\text{s}$; $V_{GS} = 0\text{ V}$; $V_{DS} = 20\text{ V}$		-	15	-	nC

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
S	softness factor	$I_S = 15\text{ A}$; $dI_S/dt = -100\text{ A}/\mu\text{s}$; $V_{GS} = 0\text{ V}$; $V_{DS} = 20\text{ V}$; $T_j = 25\text{ }^\circ\text{C}$		-	0.61	-	

[1] 40A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	 LPAK33 (SOT1210)	 mbb076
2	S	source		
3	S	source		
4	G	gate		
mb	D	Mounting base; connected to drain		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BUK9M8R5-40H	LPAK33	Plastic, single ended surface mounted package (LPAK33); 8 leads; 0.65 mm pitch	SOT1210

7. Marking

Table 4. Marking codes

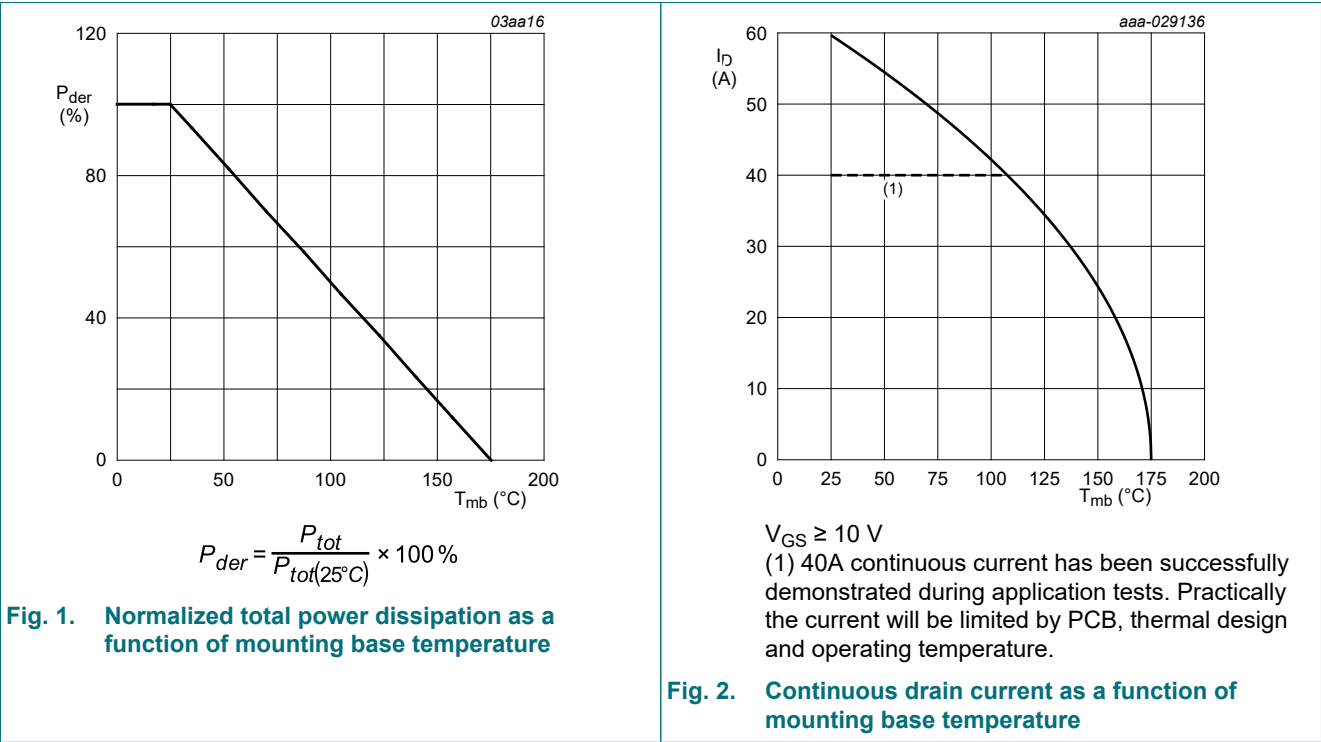
Type number	Marking code
BUK9M8R5-40H	98H540

8. Limiting values

Table 5. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134). Tj = 25 °C unless otherwise stated.

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	40	V
V _{GS}	gate-source voltage			-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; Fig. 1		-	59	W
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; Fig. 2	[1]	-	40	A
		V _{GS} = 10 V; T _{mb} = 100 °C; Fig. 2		-	40	A
I _{DM}	peak drain current	pulsed; t _p ≤ 10 μs; T _{mb} = 25 °C; Fig. 3		-	239	A
T _{stg}	storage temperature			-55	175	°C
T _j	junction temperature			-55	175	°C
Source-drain diode						
I _S	source current	T _{mb} = 25 °C		-	40	A
I _{SM}	peak source current	pulsed; t _p ≤ 10 μs; T _{mb} = 25 °C		-	239	A
Avalanche ruggedness						
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	I _D = 40 A; V _{sup} ≤ 40 V; R _{GS} = 50 Ω; V _{GS} = 10 V; T _{j(init)} = 25 °C; unclamped; Fig. 4	[2] [3]	-	24	mJ

- [1] 40A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.
- [2] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.
- [3] Refer to application note AN10273 for further information.



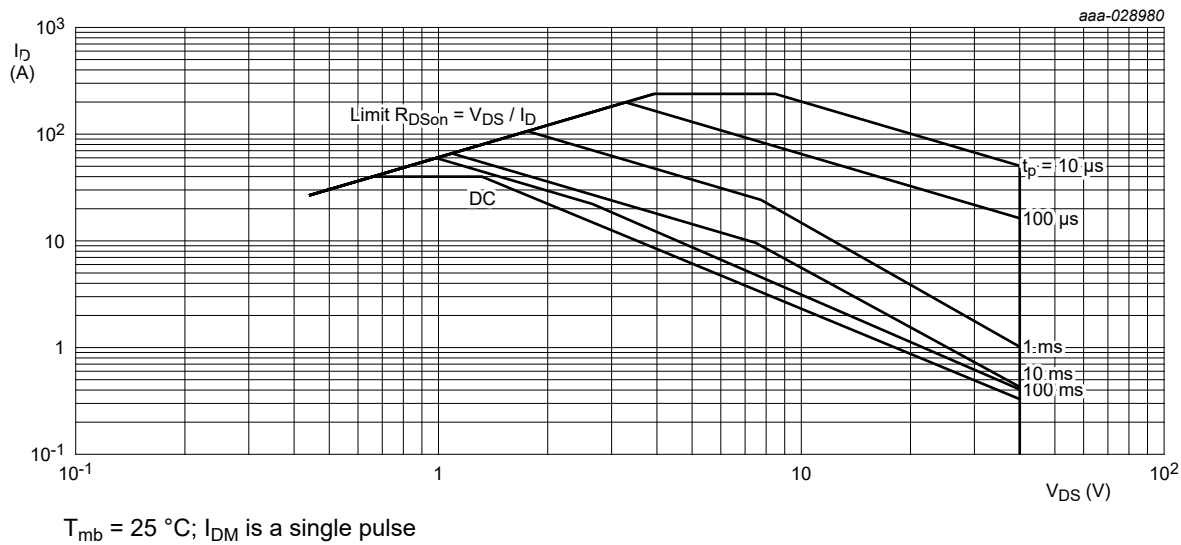
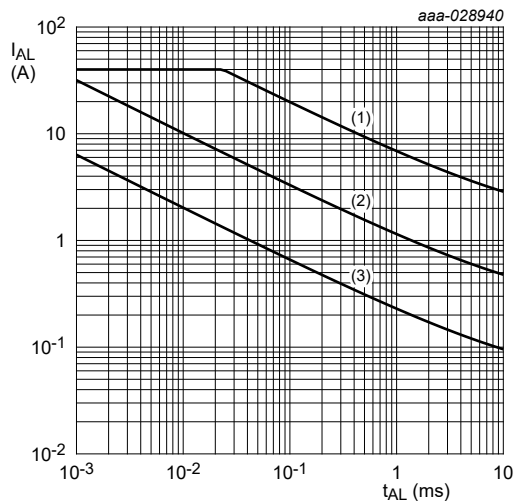


Fig. 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage



(1) $T_{j (init)} = 25^\circ C$; (2) $T_{j (init)} = 150^\circ C$; (3) Repetitive Avalanche

Fig. 4. Avalanche rating; avalanche current as a function of avalanche time

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	Fig. 5		-	2.33	2.56	K/W

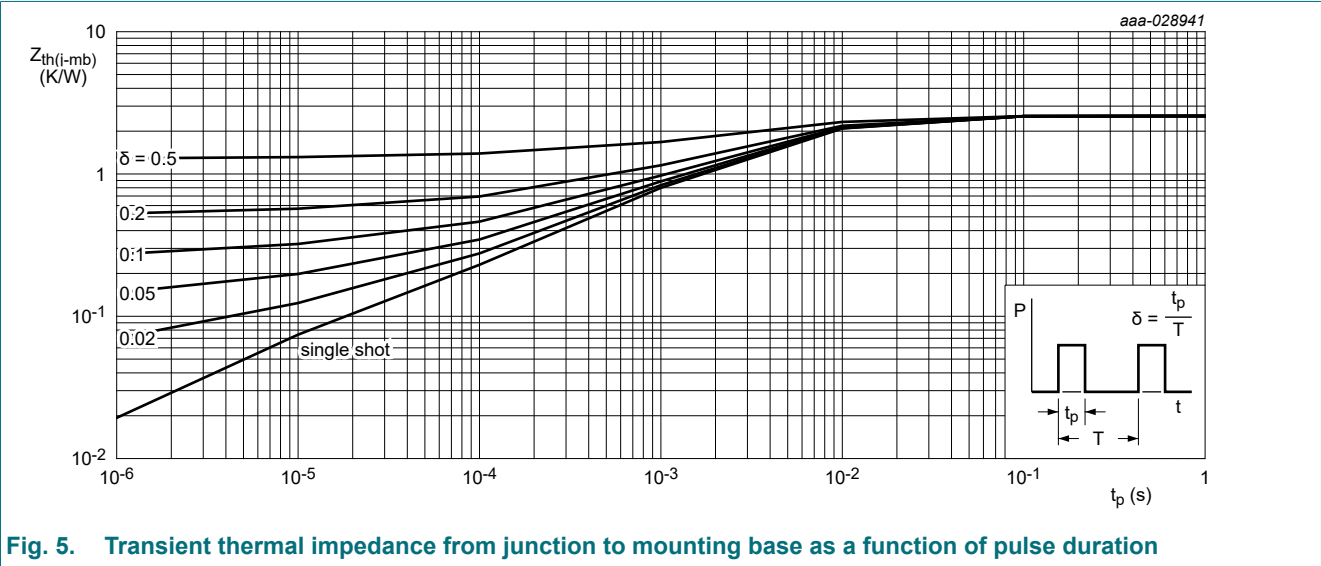


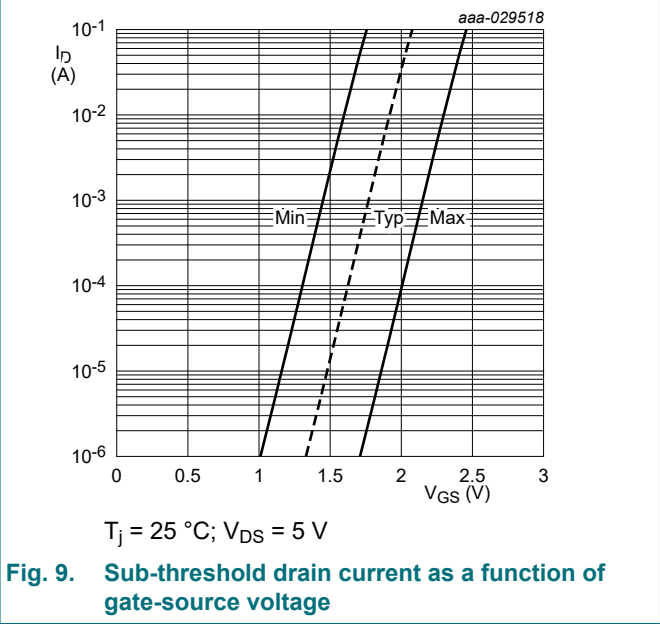
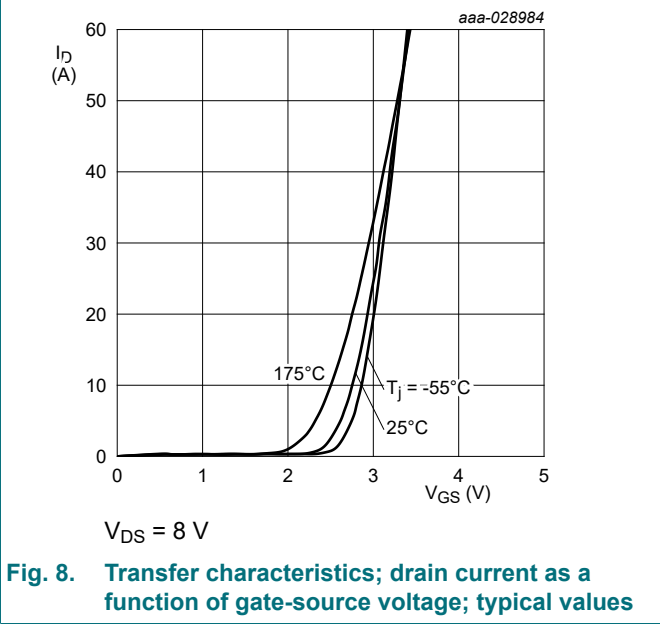
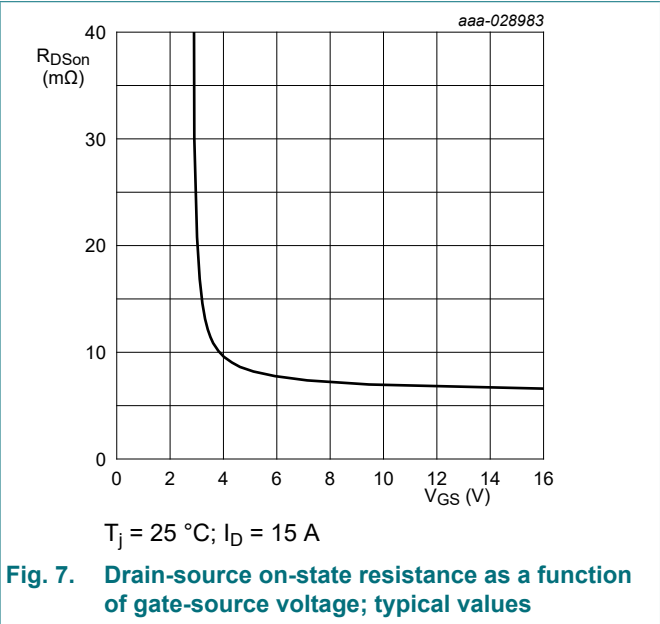
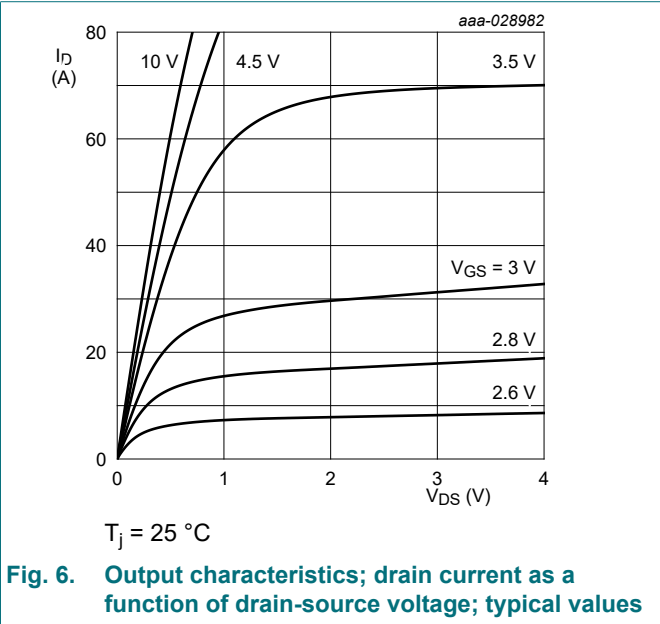
Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Static characteristics							
V _{(BR)DSS}	drain-source breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _J = 25 °C		40	43	-	V
		I _D = 250 μA; V _{GS} = 0 V; T _J = -40 °C		-	40.5	-	V
		I _D = 250 μA; V _{GS} = 0 V; T _J = -55 °C		36	40	-	V
V _{GS(th)}	gate-source threshold voltage	I _D = 1 mA; V _{DS} =V _{GS} ; T _J = 25 °C; Fig. 9 ; Fig. 10		1.45	1.77	2.15	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _J = -55 °C; Fig. 10		-	-	2.6	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _J = 175 °C; Fig. 10		0.7	-	-	V
I _{DSS}	drain leakage current	V _{DS} = 40 V; V _{GS} = 0 V; T _J = 25 °C		-	0.02	1	μA
		V _{DS} = 16 V; V _{GS} = 0 V; T _J = 125 °C		-	0.42	10	μA
		V _{DS} = 40 V; V _{GS} = 0 V; T _J = 175 °C		-	30	500	μA
I _{GSS}	gate leakage current	V _{GS} = 16 V; V _{DS} = 0 V; T _J = 25 °C		-	2	100	nA
		V _{GS} = -16 V; V _{DS} = 0 V; T _J = 25 °C		-	2	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 15 A; T _J = 25 °C; Fig. 11		5	7.2	8.5	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _J = 105 °C; Fig. 12		6.8	10.2	12.8	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _J = 125 °C; Fig. 12		7.5	11.1	13.7	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _J = 175 °C; Fig. 12		9.1	13.5	16.5	mΩ
		V _{GS} = 4.5 V; I _D = 15 A; T _J = 25 °C; Fig. 11		6.3	9	11	mΩ
		V _{GS} = 4.5 V; I _D = 15 A; T _J = 105 °C; Fig. 12		8.6	12.7	16.5	mΩ
		V _{GS} = 4.5 V; I _D = 15 A; T _J = 125 °C; Fig. 12		9.5	13.8	17.7	mΩ
		V _{GS} = 4.5 V; I _D = 15 A; T _J = 175 °C; Fig. 12		11.5	16.7	21.4	mΩ
R _G	gate resistance	f = 1 MHz; T _J = 25 °C		0.3	0.8	2	Ω
Dynamic characteristics							
Q _{G(tot)}	total gate charge	I _D = 15 A; V _{DS} = 20 V; V _{GS} = 10 V; Fig. 13 ; Fig. 14		-	20	28	nC
		I _D = 15 A; V _{DS} = 20 V; V _{GS} = 4.5 V; Fig. 13 ; Fig. 14		-	9	13	nC
Q _{GS}	gate-source charge			-	3.6	5.4	nC
Q _{GD}	gate-drain charge			-	2.1	4.2	nC
C _{iss}	input capacitance	V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz; T _J = 25 °C; Fig. 15		-	1286	1800	pF
C _{oss}	output capacitance			-	345	483	pF
C _{rss}	reverse transfer capacitance			-	49	108	pF
t _{d(on)}	turn-on delay time	V _{DS} = 20 V; R _L = 1.2 Ω; V _{GS} = 4.5 V; R _{G(ext)} = 5 Ω		-	9.5	-	ns
t _r	rise time			-	9.4	-	ns
t _{d(off)}	turn-off delay time			-	11	-	ns

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t _f	fall time		-	5.6	-	ns
Source-drain diode						
V _{SD}	source-drain voltage	I _S = 15 A; V _{GS} = 0 V; T _J = 25 °C; Fig. 16	-	0.85	1.2	V
t _{rr}	reverse recovery time	I _S = 15 A; dI _S /dt = -100 A/μs; V _{GS} = 0 V; V _{DS} = 20 V	-	22	-	ns
Q _r	recovered charge		-	15	-	nC
S	softness factor	I _S = 15 A; dI _S /dt = -100 A/μs; V _{GS} = 0 V; V _{DS} = 20 V; T _J = 25 °C	-	0.61	-	
		I _S = 15 A; dI _S /dt = -500 A/μs; V _{GS} = 0 V; V _{DS} = 20 V; T _J = 25 °C	-	0.41	-	



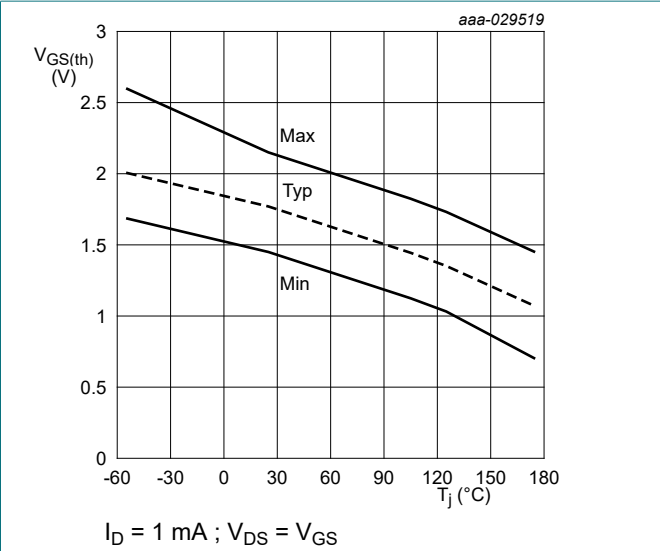


Fig. 10. Gate-source threshold voltage as a function of junction temperature

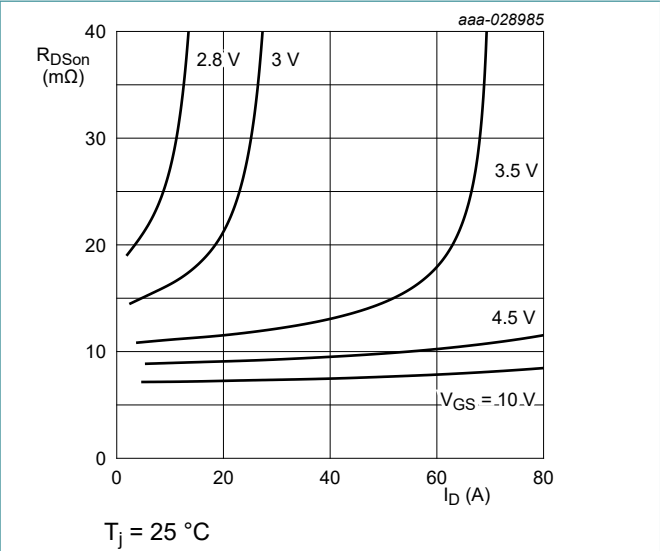


Fig. 11. Drain-source on-state resistance as a function of drain current; typical values

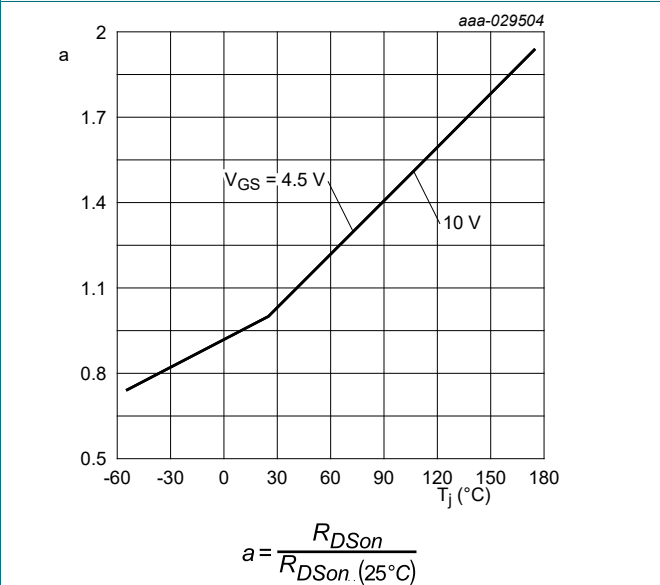


Fig. 12. Normalized drain-source on-state resistance factor as a function of junction temperature

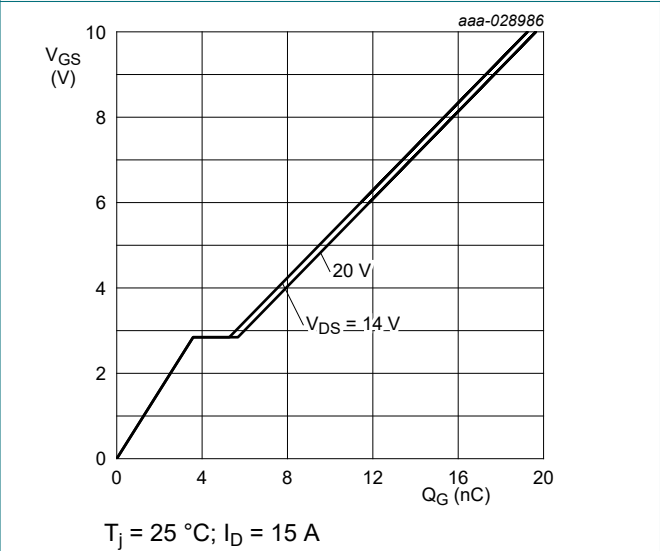
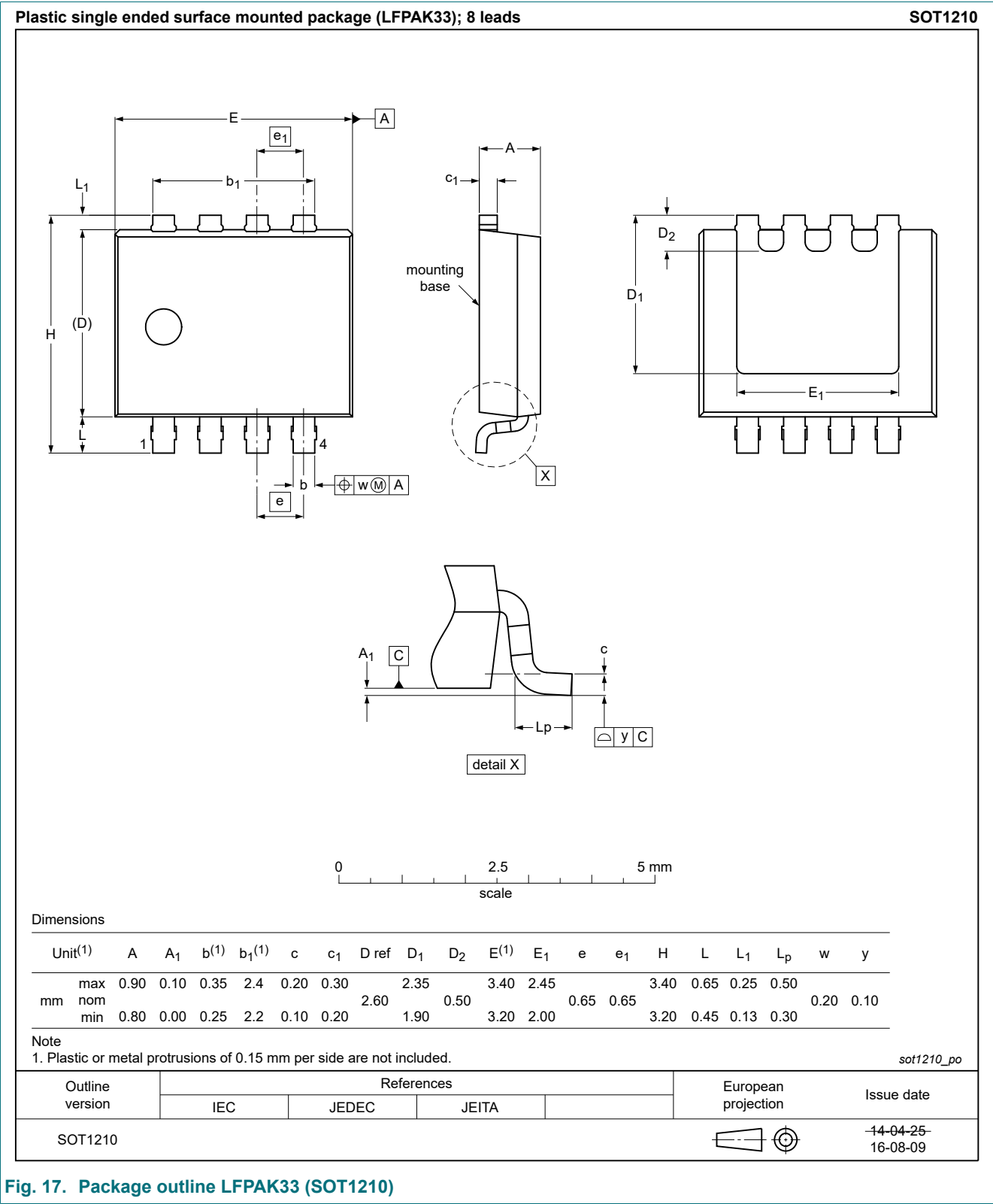


Fig. 13. Gate-source voltage as a function of gate charge; typical values

11. Package outline



12. Soldering

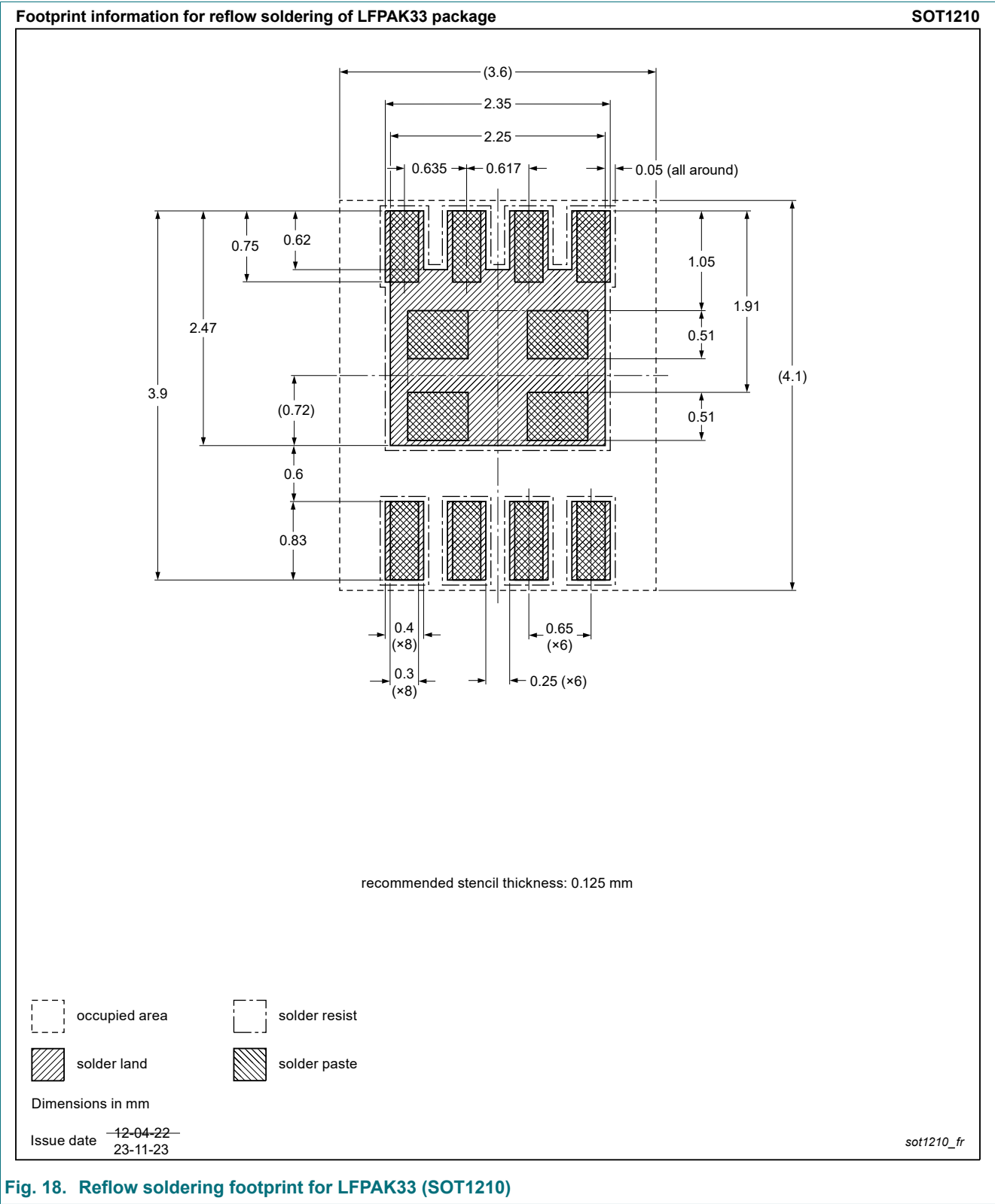


Fig. 18. Reflow soldering footprint for LFPAK33 (SOT1210)

13. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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- [2] The term 'short data sheet' is explained in section "Definitions".
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